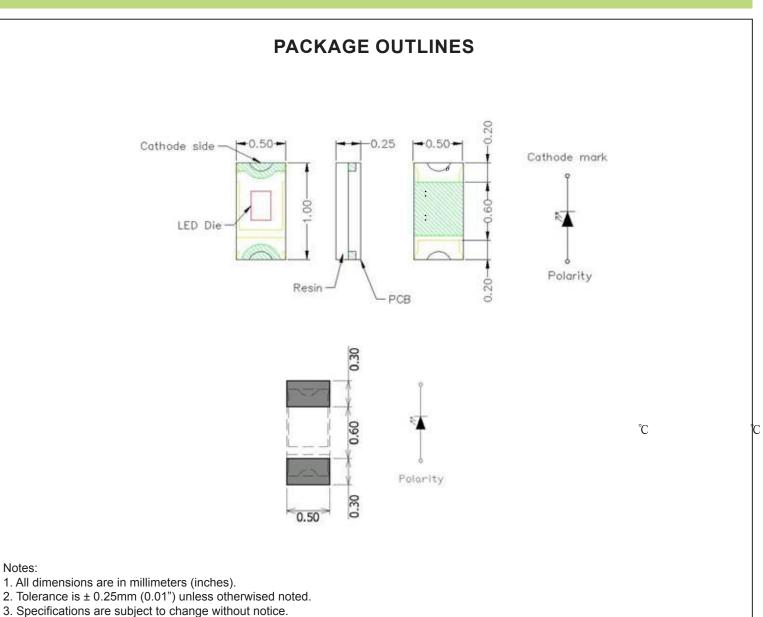


SPECIFICATION



Part Number	°C Chip Material	Color of Emission	Lens Type	Viewing Angle
CS42EB2C	InGaN	Blue	Water Clear	130°



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

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ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Forward Current	lF	20	mA
Reverse Current @ 5V	lR	10	μA
Power Dissipation	Pd	80	mW
Operating Temperature Range	Тор	-40~+85	°C
Storage Temperature Range	Тѕтс	-40~+100	°C
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	30	mA
Soldering Temperature	TSOL	Max 260°C for 10 sec Max	

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

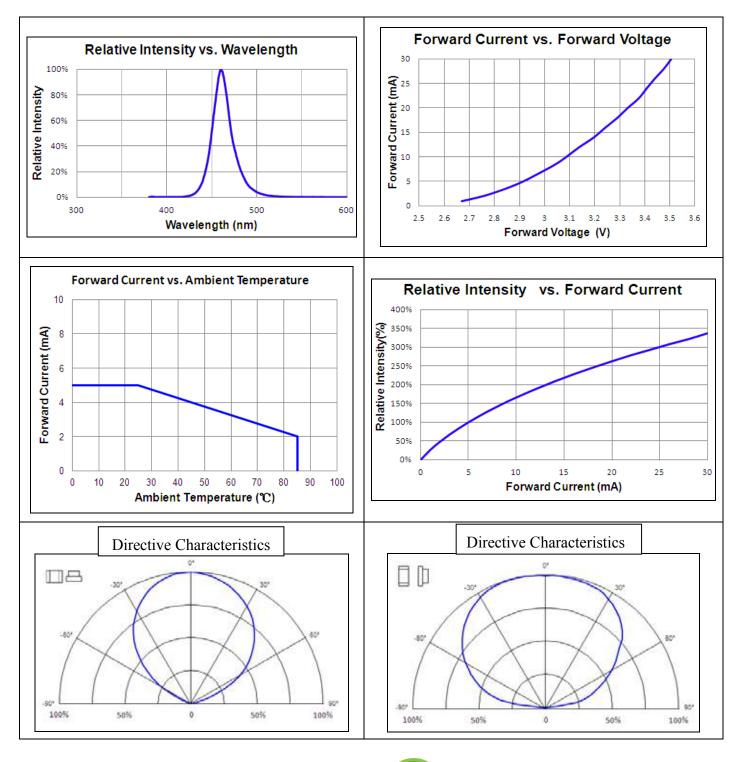
Deremeter	Cymbol	Test Condition	Value			Linit
Parameter	Symbol Test		Min	Тур	Max	Unit
Luminous Intensity	Iv	lF = 5mA	-	30	-	mcd
Forward Voltage	Vf	IF = 5mA	-	2.8	3.15	V
Reverse Leakage Current	lr	VR = 5V	-	10	-	μA
Viewing Angle at 50% Iv	201/2	IF = 5mA	-	130	-	Deg
Peak Wavelength	λp	IF = 5mA	-	460	-	nm
Dominant Wavelength	λD	IF = 5mA	-	465	-	nm

*Tolerance of viewing angle: -10 / +5 deg.





OPTICAL CHARACTERISTIC CURVES

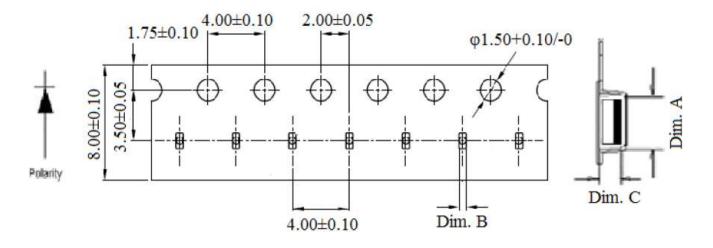






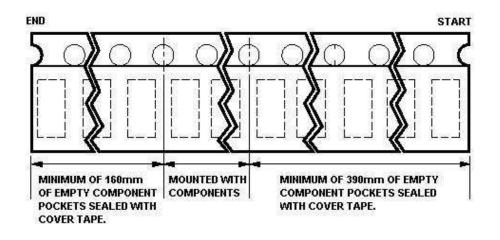
PACKAGING SPECIFICATION

Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.11±0.03	0.60±0.03	0.38±0.03	ЗK

Unit: mm







SOLDERING CONDITIONS

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220° C ,60 sec.
- 2. Peak temp.:260°C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

TIME

Lead-free Solder Profile

Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50° C x 30sec. or <30 $^{\circ}$ C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

